

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT5399658

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HONG FU JIN PRECISION INDUSTRY (ShenZhen) CO., LTD.	09/21/2018
HON HAI PRECISION INDUSTRY CO., LTD.	09/21/2018
RECEIVING PARTY DATA	
Name:	FOXCONN INTERCONNECT TECHNOLOGY LIMITED
Street Address:	Cricket Square, Hutchins Drive, P.O. Box 2681, Grand Cayman KY1-1111, Cayman Islands
City:	Grand Cayman
State/Country:	CAYMAN ISLANDS
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15588800
CORRESPONDENCE DATA	
Fax Number:	(213)426-1788
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	2134261771
Email:	eoaproce@scienbizip.com, eoacbd@scienbizip.com, eoaprocc@sbp-us.com
Correspondent Name:	CALVIN H CHAI
Address Line 1:	550 S. HOPE STREET, SUITE 2825
Address Line 4:	LOS ANGELES, CALIFORNIA 90071
ATTORNEY DOCKET NUMBER:	US60359
NAME OF SUBMITTER:	CALVIN H CHAI
SIGNATURE:	/Calvin H Chai/
DATE SIGNED:	03/01/2019
Total Attachments: 2	
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PATENT ASSIGNMENT AGREEMENT

Hon Hai Precision Industry Co., Ltd. and Hongfujin Precision Industry (Shenzhen) Co., Ltd. (the "ASSIGNOR") are owners of patents listed in Exhibit A, (the "Patents"). Foxconn Interconnect Technology Limited (the "ASSIGNEE") desires to acquire rights in and to the Patents, and has entered into an Assets Transfer Agreement (the "Transfer Agreement") with ASSIGNOR, effective May 28, 2018, whereby terms, conditions and considerations for the assignment of the PATENTS were agreed upon.

Therefore, for valuable consideration, the receipt of which is acknowledged, ASSIGNOR hereby assigns to ASSIGNEE all of its right, title, and interest in the invention and Patents to ASSIGNEE for the entire term of the Patents and any reissues or extensions thereof, and for the entire term of any patents, reissues, or extensions that may issue from foreign applications, divisions, continuations in whole or in part, or substitute applications filed claiming the benefit of the Patents. The right, title, and interest conveyed in this Assignment is to be held and enjoyed by ASSIGNEE and ASSIGNEE's successors as fully and exclusively as it would have been held and enjoyed by ASSIGNOR prior to making this assignment.

ASSIGNOR further agrees to: (a) cooperate with ASSIGNEE in the protection of the patent rights and prosecution and protection of foreign counterparts; (b) execute, verify, acknowledge and deliver all such further papers, including patent applications and instruments of transfer; and (c) perform such other acts as ASSIGNEE lawfully may request to obtain or maintain the Patents and any and all applications and registrations for the invention in any and all countries.

In the event of any conflicts between this Agreement and the Transfer Agreement, the Transfer Agreement shall prevail.

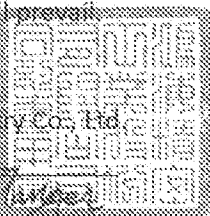
ASSIGNOR

Hon Hai Precision Industry Co., Ltd.

By: [Signature]

Title: General Manager

Date: 2018.9.18

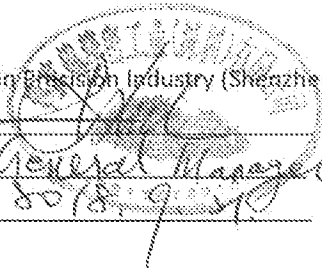


Hongfujin Precision Industry (Shenzhen) Co., Ltd.

By: [Signature]

Title: General Manager

Date: 2018.9.18



For and on behalf of
FOXCONN INTERCONNECT

ASSIGNEE

Foxconn Interconnect Technology Limited

By: [Signature]

Title: Vice President

Date: 2018.9.18

2018TW-L-K-2208



EXHIBIT A

Appl. No.	Country
13/847054	US
13/922838	US
14/014780	US
14/066705	US
14/262879	US
14/291266	US
14/587288	US
14/311589	US
14/546182	US
14/754184	US
14/540204	US
14/595218	US
14/560072	US
14/656444	US
14/680541	US
14/614801	US
14/481889	US
14/510977	US
14/525814	US
29/513189	US
14/847741	US
14/558952	US
14/725888	US
14/718538	US
14/842233	US
14/858081	US
14/788102	US
14/687591	US
14/688656	US
14/819925	US
14/687645	US
14/753832	US
14/755824	US
14/821120	US
14/755846	US

Appl. No.	Country
14/755867	US
14/755867	US
14/755911	US
14/821257	US
14/821131	US
14/821142	US
14/835334	US
14/812673	US
14/585467	US
14/716383	US
14/583836	US
14/549739	US
14/641836	US
14/642402	US
14/591109	US
29/480040	US
29/470572	US
14/310078	US
14/182300	US
13/034689	US
15/588800	US
29/589321	US
特願 2015-003057	JP
特願 2015-071344	JP
特願 2015-065982	JP
特願 2015-016633	JP
特願 2015-079850	JP
特願 2015-019129	JP
特願 2015-019126	JP
特願 2015-123661	JP
特願 2015-138584	JP
特願 2015-128532	JP
特願 2015-025150	JP
002335117-0001	EC
102013005587.9	DE



TECHNOLOGY LIMITED
 (Authorized Signatures)

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